

General Description

The MAX5101 parallel-input, voltage-output, triple 8-bit digital-to-analog converter (DAC) operates from a single +2.7V to +5.5V supply and comes in a space-saving 16-pin TSSOP package. Internal precision buffers swing rail-to-rail. For all three DACs, the internal reference voltage is tied to VDD.

The MAX5101 has separate input latches for each of its three DACs. Data is transferred to the input latches from a common 8-bit input port. The DACs are individually selected through address inputs A0 and A1 and are updated by bringing WR low.

The MAX5101 features a 1µA software shutdown mode, as well as a power-on reset mode that resets all registers to code 00 hex on power-up.

Applications

Digital Gain and Offset Adjustment Programmable Attenuators

Portable Instruments

Power-Amp Bias Control

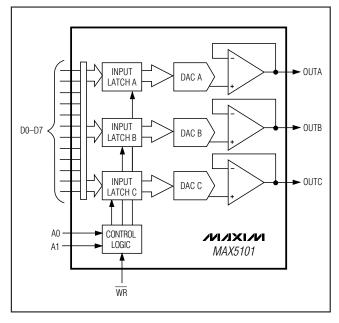
Features

- ♦ +2.7V to +5.5V Single-Supply Operation
- ♦ Ultra-Low Supply Current 0.3mA while Operating 1µA in Software Shutdown Mode
- ♦ Ultra-Small 16-Pin TSSOP Package
- ♦ Output Buffer Amplifiers Swing Rail-to-Rail
- ♦ Power-On Reset Sets All Registers to Zero

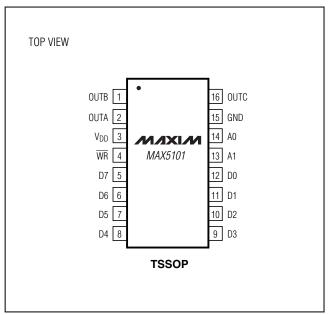
Ordering Information

PART	TEMP RANGE	PIN- PACKAGE	INL (LSB)
MAX5101AEUE	-40°C to +85°C	16 TSSOP	±1
MAX5101BEUE	-40°C to +85°C	16 TSSOP	±2

Functional Diagram



Pin Configuration



Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

ABSOLUTE MAXIMUM RATINGS

V _{DD} to GND	0.3V to +6V
D_, A_, WR to GND	0.3V to +6V
OUT_ to GND	0.3V to V _{DD}
Maximum Current into Any Pin	±50mA
Continuous Power Dissipation ($T_A = +70^{\circ}C$:)
16-Pin TSSOP (derate 5.7mW/°C above +	-70°C)457mW

Operating Temperature Range	
MAX5101_EUE	40°C to +85°C
Maximum Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{DD} = +2.7 V \text{ to } +5.5 V, R_L = 10 k\Omega, C_L = 100 pF, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.}$ Typical values are at $V_{DD} = +3 V$ and $T_A = +25 ^{\circ}C.)$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
STATIC ACCURACY	•		-1				
Resolution					8	Bits	
Later and Discriber with Ablata 4	INL	MAX5101A			±1	±1 ±2 LSB	
Integral Nonlinearity (Note 1)		MAX5101B			±2		
Differential Nonlinearity (Note 1)	DNL	Guaranteed monotonic			±1	LSB	
Zero-Code Error	ZCE	Code = 00 hex			±20	mV	
Zero-Code-Error Supply Rejection		Code = 00 hex, V _{DD} = 2.7V to 5.5V			10	mV	
Zero-Code Temperature Coefficient		Code = 00 hex		±10		μV/°C	
Gain Error (Note 2)		Code = F0 hex			±1	%	
Gain-Error Temperature Coefficient		Code = F0 hex	±0.001			LSB/°C	
DAC OUTPUTS	1						
Output Voltage Range		RL = ∞	0		V_{DD}	V	
DIGITAL INPUTS			•				
Input High Voltage	VIH	V _{DD} = 2.7V to 3.6V	2			V	
input riigir voltage	VIH	V _{DD} = 3.6V to 5.5V	3		v		
Input Low Voltage	VIL				0.8	V	
Input Current	IIN	$V_{IN} = V_{DD}$ or GND			±1.0	μΑ	
Input Capacitance	CIN			10		pF	
DYNAMIC PERFORMANCE							
Output Voltage Slew Rate		From code 00 to code F0 hex		0.6		V/µs	
Output Settling Time (Note 3)		To 1/2LSB, from code 10 to code F0 hex		6		μs	
Channel-to-Channel Isolation (Note 4)		Code 00 to code FF hex		500		nVs	
Digital Feedthrough (Note 5)		Code 00 to code FF hex		0.5		nVs	

2 /V|/1X|/VI

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{DD} = +2.7V \text{ to } +5.5V, R_L = 10k\Omega, C_L = 100pF, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } V_{DD} = +3V \text{ and } T_A = +25^{\circ}C.)$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Digital-to-Analog Glitch Impulse		Code 80 hex to code 7F hex		90		nVs
Wideband Amplifier Noise				60		μVRMS
Shutdown Recovery Time	tsdr	To ±1/2LSB of final value of V _{OUT}		13		μs
Time to Shutdown	tsdn	I _{DD} < 5µA		20		μs
POWER SUPPLIES						
Power-Supply Voltage	V_{DD}		2.7		5.5	V
Supply Current (Note 6)	I _{DD}			280	520	μΑ
Shutdown Current				1	3	μΑ
DIGITAL TIMING (Figure 1) (Note	DIGITAL TIMING (Figure 1) (Note 7)					
Address to WR Setup	tas		5			ns
Address to WR Hold	t _{AH}		0			ns
Data to WR Setup	t _{DS}		25			ns
Data to WR Hold	tDH		0			ns
WR Pulse Width	twR		20			ns

- Note 1: Reduced digital code range (code 00 hex to code F0 hex) due to swing limitations when the output amplifier is loaded.
- Note 2: Gain error is: [100 (VF0,meas ZCE VF0,ideal) / VDD]. Where VF0,meas is the DAC output voltage with input code F0 hex, and VF0,ideal is the ideal DAC output voltage with input code F0 hex (i.e., VDD 240 / 256).
- **Note 3:** Output settling time is measured from the 50% point of the falling edge of \overline{WR} to $\pm 1/2LSB$ of V_{OUT} 's final value.
- Note 4: Channel-to-Channel Isolation is defined as the glitch energy at a DAC output in response to a full-scale step change on any other DAC output. The measured channel has a fixed code of 80 hex.
- Note 5: Digital Feedthrough is defined as the glitch energy at any DAC output in response to a full-scale step change on all eight data inputs with WR at V_{DD}.
- **Note 6:** $R_L = \infty$, digital inputs at GND or V_{DD} .
- Note 7: Timing measurement reference level is (V_{IH} + V_{IL}) / 2.

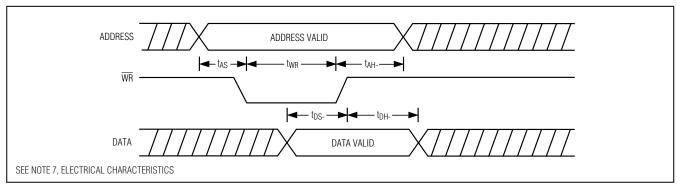
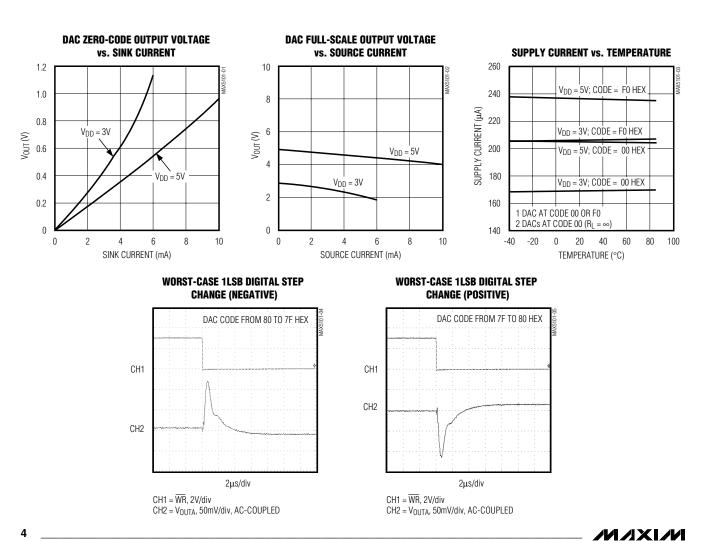


Figure 1. Timing Diagram

Typical Operating Characteristics

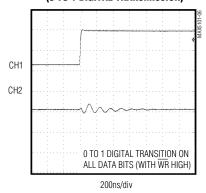
 $(V_{DD} = +3V, R_L = 10k\Omega, C_L = 100pF, code = FF hex, T_A = +25^{\circ}C, unless otherwise noted.)$



_Typical Operating Characteristics (continued)

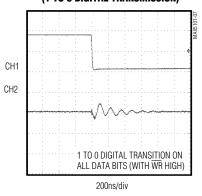
 $(V_{DD} = +3V, R_L = 10k\Omega, C_L = 100pF, code = FF hex, T_A = +25°C, unless otherwise noted.)$

DIGITAL FEEDTHROUGH GLITCH IMPULSE (O TO 1 DIGITAL TRANSMISSION)



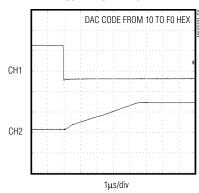
CH1 = D7, 2V/div CH2 = V_{OUTA}, 1mV/div, AC-COUPLED

DIGITAL FEEDTHROUGH GLITCH IMPULSE (1 TO 0 DIGITAL TRANSMISSION)



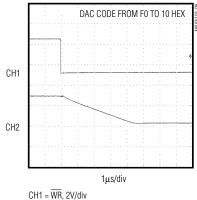
CH1 = D7, 2V/div $CH2 = V_{OUTB}$, 1mV/div, AC-COUPLED

POSITIVE SETTLING TIME



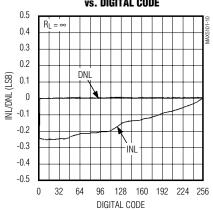
 $\begin{aligned} CH1 &= \overline{WR}, \, 2V/div \\ CH2 &= V_{OUTA}, \, 2V/div \end{aligned}$

NEGATIVE SETTLING TIME



 $CH2 = V_{OUTA}$, 2V/div

INTEGRAL AND DIFFERENTIAL NONLINEARITY vs. DIGITAL CODE



Pin Description

PIN	NAME	FUNCTION		
1	OUTB	DAC B Voltage Output		
2	OUTA	DAC A Voltage Output		
3	V _{DD}	Positive Supply Voltage. Bypass VDD to GND using a 0.1µF capacitor.		
4	WR	Write Input (active low). Use WR to load data into the DAC input latch selected by A0 and A1.		
5–12	D7-D0	Data Inputs 7–0		
13	A1	DAC Address Select Bit (MSB)		
14	A0	DAC Address Select Bit (LSB)		
15	GND	Ground		
16	OUTC	DAC C Voltage Output		

Detailed Description

Digital-to-Analog Section

The MAX5101 uses a matrix decoding architecture for the digital-to-analog converters (DACs). The internal reference voltage is connected to VDD and divided down by a resistor string placed in a matrix fashion. Row and column decoders select the appropriate tab from the resistor string to provide the needed analog voltages. The resistor network converts the 8-bit digital input into an equivalent analog output voltage in proportion to the supply voltage (VDD). The resistor string presents a code-independent input impedance to the supply and guarantees a monotonic output.

The voltages are buffered by rail-to-rail op amps connected in a follower configuration to provide a rail-to-rail output (see *Functional Diagram*).

Output Buffer Amplifiers

The DAC outputs are internally buffered by a precision amplifier with a typical slew rate of 0.6V/ μ s. The typical settling time to $\pm 1/2$ LSB at the output is 6 μ s when loaded with 10k Ω in parallel with 100pF.

DAC Reference Voltage

The MAX5101's reference is internally tied to V_{DD}. The output voltage (V_{OUT}) for any DAC is represented by a digitally programmable voltage source as follows:

 $V_{OUT} = (N_B \cdot V_{DD}) / 256$

where NB is the numeric value of the DAC binary input code.

Digital Inputs and Interface Logic

In the MAX5101, address lines A0 and A1 select the DAC that receives data from D0–D7, as shown in Table 1. When \overline{WR} is low, the addressed DAC's input latch is transparent. Data is latched when \overline{WR} is high. The DAC outputs (OUTA, OUTB) represent the data held in the three 8-bit input latches. To avoid output glitches in the MAX5101, ensure that data is valid before \overline{WR} goes low.

Low-Power Shutdown Mode

The MAX5101 features a software shutdown mode. A write performed to address A1 = H and A0 = H causes the device to shut down. A subsequent write to any of the other three addresses disables shutdown and turns the analog circuitry on. As the MAX5101 comes out of shutdown, all registers retain their digital values prior to shutdown. However, when the device powers up (i.e., VDD ramps up), all latches are internally preset with code 00 hex. In shutdown, the output amplifiers enter a high-impedance state. When bringing the device out of shutdown, allow 13 μ s for the output to stabilize.

Power-Supply Bypassing and Ground Management

Digital or AC transient signals on GND can create noise at the analog output. Return GND to the highest-quality ground available. Bypass VDD with a 0.1µF capacitor, located as close to VDD and GND as possible.

Careful PC board ground layout minimizes crosstalk between the DAC outputs and digital inputs.

Table 1. MAX5101 Addressing Table (partial)

	Chip	Information
TRANSISTOR COUNT: 6848	3	

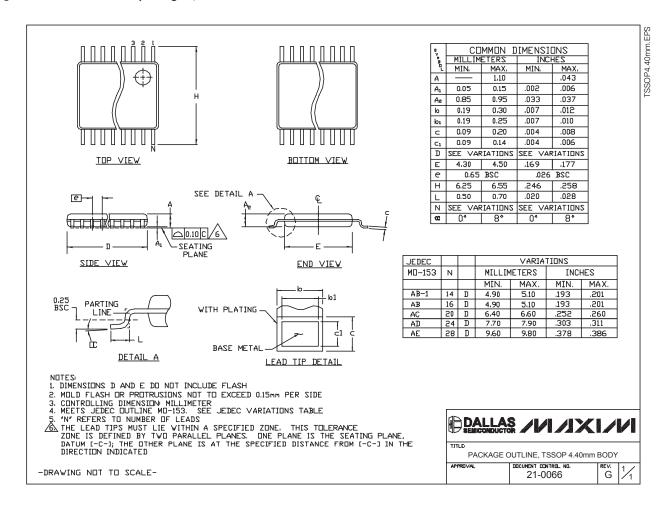
WR	A1	A0 OPERATION	
Н	Х	Х	Input data latched
L	L	L	DAC A input latch transparent
L	L	Н	DAC B input latch transparent
L	Н	L	DAC C input latch transparent
L	Н	Н	Enter shutdown mode

H = high state, L = low state, X = don't care



Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



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